



KOH YOUNG TECHNOLOGY POISED FOR GROWTH; CUSTOMERS BENEFIT

Dear Koh Young Friends,

Koh Young Technology is about to enter an exciting new phase with the decision to become a public company, effective June 3, 2008. This is a major milestone for Koh Young, and good news for all its customers and friends.

Becoming a public company gives Koh Young the resources it needs to grow, to invest in new vision technology development and to build a stronger infrastructure to better serve our customers. Our team will grow as well, because we'll be able to attract top engineers and technicians to develop world-class products and provide ever-better localized support around the world for our valued customers.

There are many reasons why becoming a public company is the inevitable and appropriate next step for Koh Young.

Koh Young Technology has become the world leader in 3-D measurement and inspection. Koh Young is reinforcing world market controlling power in 3-D SPI system business and expanding its business to 3-D inspection for semiconductor back-end processes.

The industry recognizes our team's achievements; Koh Young Technology has been awarded a Vision Award (Best New Product of Year 2007) by the authoritative SMT Magazine.

With a 48.9% CAGR for the last three years, Koh Young is leading the 3-D solder paste inspection system market, now heading into a phase of dramatic growth. Koh Young is planning to capitalize on this explosive market expansion. To do this, the company needs the investment available to a public company.

Koh Young introduced world's first profilometric-based 3D inspection system for semiconductor back-end process last January and is already receiving an enthusiastic response from the market.

These are exciting times for Koh Young Technology; the future holds great promise and possibility. To all of our valued customers and distributors, we thank you for your understanding and support. Please stay with us on this journey as we prosper together. Moreover, we invite all of our friends to join the Koh Young team in growth and celebration as we move forward into this new phase.

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Sincerely,

Dr Kwangill Koh
CEO

Thorsten Niermeyer
Director Sales

UPCOMING EXHIBITIONS

REPORT SMT SHOW, NUREMBERG

At SMT Hybrid Show in Nuremberg, Germany, 3-5 June, Koh Young Technology was selected to be the measurement system in Paste Printer Benchmark line, organised by the EPP magazine. With much attention from show visitors, live printing of 4 different screen printers took place 5 times a day. Koh Young displayed measurement results after each print within 3 minutes to show highlights and possible defects. While Speedprint, DEK, EKRA and essemtec were competing for best and most consistent print results, Koh Young provided them with vital feedback for print optimisation over the 3 day event. Articles with a full presentation and discussion of the results will be published in the EPP and EPP Europe magazines.

JPCA SHOW, TOKYO BIG SIGHT, JAPAN, 11-13 JUNE 2008.

At this show Koh Young will display the latest SPI equipment. The aSPIre with SPC-Plus, the Prime with Bump inspection and the KY 8030 equipment. A separate demo area for SPC-Plus software demonstrations is inside the booth 1G/09



SEMICON WEST, MOSCONE CENTER, SAN FRANCISCO, CA, USA, 15-17 JULY 2008

This semi conductor show is focused on the manufacturing of semicon products. Koh Young will be present with our Prime, the first 3D bump inspection system.